

# 1 Absolute maximum ratings and operating conditions

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply voltage	+18	V
$I_{OUT}$	Output current	$\pm 100$	mA
$R_{thja}$	Thermal resistance junction to ambient DIP14 <sup>(1)</sup> SO14 <sup>(2)</sup>	80 105	°C/W
$R_{thjc}$	Thermal resistance junction to case DIP14 <sup>(1)</sup> SO14 <sup>(2)</sup>	33 31	°C/W
$T_j$	Junction Temperature	+150	°C
$T_{stg}$	Storage Temperature Range	-65 to +150	°C
ESD	Human body model (HBM) <sup>(3)</sup>	1200	V
	Machine model (MM) <sup>(4)</sup>	200	
	Charged device model (CDM) <sup>(5)</sup>	1000	

1. Short-circuits can cause excessive heating. These values are typical and specified for a single layer PCB.
2. Short-circuits can cause excessive heating. These values are typical and specified for a four layers PCB.
3. Human body model: a 100 pF capacitor is charged to the specified voltage, then discharged through a 1.5k $\Omega$  resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
4. Machine model: a 200 pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5  $\Omega$ ). This is done for all couples of connected pin combinations while the other pins remain floating.
5. Charged device model: all pins plus package are charged together to the specified voltage and then discharged directly to the ground.

**Table 2. Operating conditions**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply voltage	2 to 16	V
$I_{OUT}$	Output sink current Output source current	10 50	mA
$T_{oper}$	Operating free air temperature range: TS556C TS556I TS556M	0 to +70 -40 to +125 -55 to +125	°C

## 2 Schematic diagram

Figure 1. Schematic diagram (1/2 TS556)

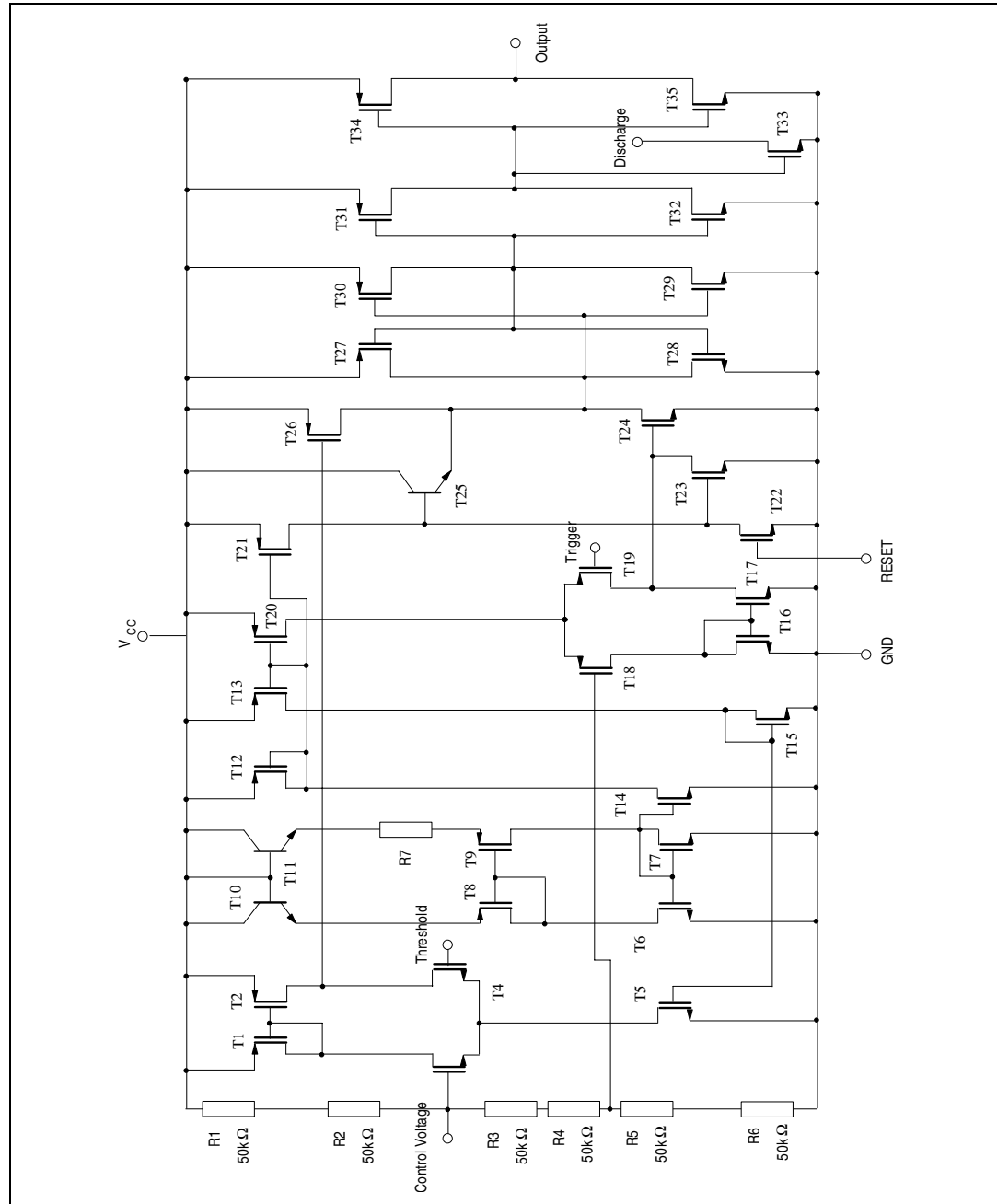


Figure 2. Block diagram

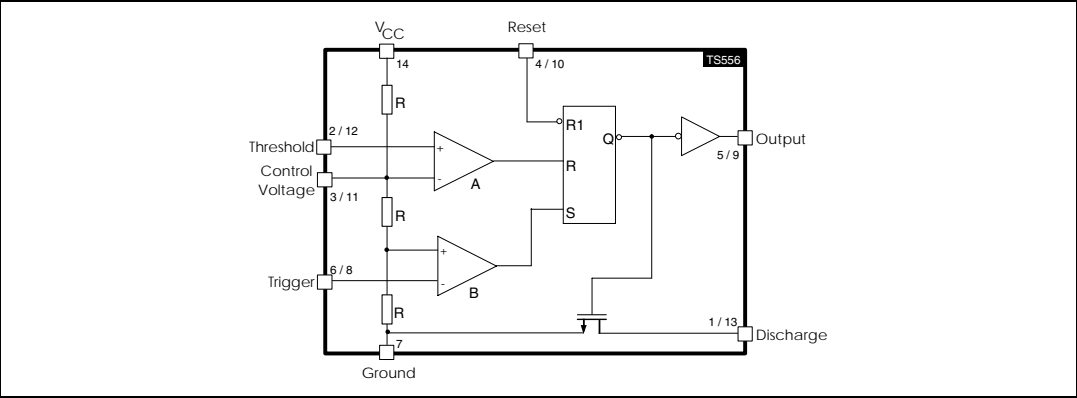


Table 3. Functions table

Reset	Trigger	Threshold	Output
Low	x	x	Low
High	Low	x	High
High	High	High	Low
High	High	Low	Previous State

Note: LOW: level voltage  $\leq$  minimum voltage specified  
HIGH: level voltage  $\geq$  maximum voltage specified  
x: irrelevant.

### 3 Electrical characteristics

**Table 4. Static electrical characteristics**  
 $V_{CC} = +2\text{ V}$ ,  $T_{amb} = +25\text{ °C}$ , Reset to  $V_{CC}$  (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
$I_{CC}$	Supply current (no load, high and low states) $T_{min.} \leq T_{amb} \leq T_{max}$		130	400 400	$\mu\text{A}$
$V_{CL}$	Control voltage level $T_{min.} \leq T_{amb} \leq T_{max}$	1.2 1.1	1.3	1.4 1.5	V
$V_{DIS}$	Discharge saturation voltage ( $I_{dis} = 1\text{ mA}$ ) $T_{min.} \leq T_{amb} \leq T_{max}$		0.05	0.2 0.25	V
$I_{DIS}$	Discharge pin leakage current		1	100	nA
$V_{OL}$	Low level output voltage ( $I_{sink} = 1\text{ mA}$ ) $T_{min.} \leq T_{amb} \leq T_{max}$		0.1	0.3 0.35	V
$V_{OH}$	High level output voltage ( $I_{source} = -0.3\text{ mA}$ ) $T_{min.} \leq T_{amb} \leq T_{max}$	1.5 1.5	1.9		V
$V_{TRIG}$	Trigger voltage $T_{min.} \leq T_{amb} \leq T_{max}$	0.4 0.3	0.67	0.95 1.05	V
$I_{TRIG}$	Trigger current		10		pA
$I_{TH}$	Threshold current		10		pA
$V_{RESET}$	Reset voltage $T_{min.} \leq T_{amb} \leq T_{max}$	0.4 0.3	1.1	1.5 2.0	V
$I_{RESET}$	Reset current		10		pA

**Table 5. Static electrical characteristics**  
 **$V_{CC} = +3\text{ V}$ ,  $T_{amb} = +25\text{ °C}$ , Reset to  $V_{CC}$  (unless otherwise specified)**

Symbol	Parameter	Min.	Typ.	Max.	Unit
$I_{CC}$	Supply current (no load, high and low states) $T_{min} \leq T_{amb} \leq T_{max}$		180	460 460	$\mu\text{A}$
$V_{CL}$	Control voltage level $T_{min} \leq T_{amb} \leq T_{max}$	1.8 1.7	2	2.2 2.3	V
$V_{DIS}$	Discharge saturation voltage ( $I_{dis} = 1\text{ mA}$ ) $T_{min} \leq T_{amb} \leq T_{max}$		0.05	0.2 0.25	V
$I_{DIS}$	Discharge pin leakage current		1	100	nA
$V_{OL}$	Low level output voltage ( $I_{sink} = 1\text{ mA}$ ) $T_{min.} \leq T_{amb} \leq T_{max}$		0.1	0.3 0.35	V
$V_{OH}$	High level output voltage ( $I_{source} = -0.3\text{ mA}$ ) $T_{min.} \leq T_{amb} \leq T_{max}$	2.5 2.5	2.9		V
$V_{TRIG}$	Trigger voltage $T_{min.} \leq T_{amb} \leq T_{max}$	0.9 0.8	1	1.1 1.2	V
$I_{TRIG}$	Trigger current		10		pA
$I_{TH}$	Threshold current		10		pA
$V_{RESET}$	Reset voltage $T_{min.} \leq T_{amb} \leq T_{max}$	0.4 0.3	1.1	1.5 2.0	V
$I_{RESET}$	Reset current		10		pA

**Table 6. Dynamic electrical characteristics**  
 **$V_{CC} = +3\text{ V}$ ,  $T_{amb} = +25\text{ }^{\circ}\text{C}$ , Reset to  $V_{CC}$  (unless otherwise specified)**

Symbol	Parameter	Min.	Typ.	Max.	Unit
	Timing accuracy (monostable) <sup>(1)</sup> $R = 10\text{ k}\Omega$ , $C = 0.1\text{ }\mu\text{F}$ $V_{CC} = +2\text{ V}$ , $V_{CC} = +3\text{ V}$		1 1		%
	Timing shift with supply voltage variations (Monostable) <sup>(1)</sup> $R = 10\text{ k}\Omega$ , $C = 0.1\text{ }\mu\text{F}$ , $V_{CC} = +3\text{ V} \pm 0.3\text{ V}$		0.5		%/V
	Timing shift with temperature <sup>(1)</sup> $T_{min.} \leq T_{amb} \leq T_{max}$		75		ppm/ $^{\circ}\text{C}$
$f_{max}$	Maximum astable frequency <sup>(2)</sup> $R_A = 470\text{ }\Omega$ , $R_B = 200\text{ }\Omega$ , $C = 200\text{ pF}$		2		MHz
	Astable frequency accuracy <sup>(2)</sup> $R_A = R_B = 1\text{ k}\Omega$ to $100\text{ k}\Omega$ , $C = 0.1\text{ }\mu\text{F}$		5		%
	Timing shift with supply voltage variations (astable mode) <sup>(2)</sup> $R_A = R_B = 10\text{ k}\Omega$ , $C = 0.1\text{ }\mu\text{F}$ , $V_{CC} = +3\text{ to }+5\text{ V}$		0.5		%/V
$t_R$	Output rise time ( $C_{load} = 10\text{ pF}$ )		25		ns
$t_F$	Output fall time ( $C_{load} = 10\text{ pF}$ )		20	-	ns
$t_{PD}$	Trigger propagation delay		100		ns
$t_{RPW}$	Minimum reset pulse width ( $V_{trig} = +3\text{ V}$ )		350		ns

1. See [Figure 4](#).

2. See [Figure 6](#).

**Table 7. Static electrical characteristics**  
 **$V_{CC} = +5\text{ V}$ ,  $T_{amb} = +25\text{ °C}$ , Reset to  $V_{CC}$  (unless otherwise specified)**

Symbol	Parameter	Min.	Typ.	Max.	Unit
$I_{CC}$	Supply current (no load, high and low states) $T_{min.} \leq T_{amb} \leq T_{max}$		220	500 500	$\mu\text{A}$
$V_{CL}$	Control voltage level $T_{min.} \leq T_{amb} \leq T_{max}$	2.9 2.8	3.3	3.8 3.9	V
$V_{DIS}$	Discharge saturation voltage ( $I_{dis} = 10\text{ mA}$ ) $T_{min.} \leq T_{amb} \leq T_{max}$		0.2	0.3 0.35	V
$I_{DIS}$	Discharge pin leakage current		1	100	nA
$V_{OL}$	Low level output voltage ( $I_{sink} = 8\text{ mA}$ ) $T_{min.} \leq T_{amb} \leq T_{max}$		0.3	0.6 0.8	V
$V_{OH}$	High level output voltage ( $I_{source} = -2\text{ mA}$ ) $T_{min.} \leq T_{amb} \leq T_{max}$	4.4 4.4	4.6		V
$V_{TRIG}$	Trigger voltage $T_{min.} \leq T_{amb} \leq T_{max}$	1.36 1.26	1.67	1.96 2.06	V
$I_{TRIG}$	Trigger current		10		pA
$I_{TH}$	Threshold current		10		pA
$V_{RESET}$	Reset voltage $T_{min.} \leq T_{amb} \leq T_{max}$	0.4 0.3	1.1	1.5 2.0	V
$I_{RESET}$	Reset current		10		pA

**Table 8. Dynamic electrical characteristics**  
 **$V_{CC} = +5\text{ V}$ ,  $T_{amb} = +25\text{ }^{\circ}\text{C}$ , Reset to  $V_{CC}$  (unless otherwise specified)**

Symbol	Parameter	Min.	Typ.	Max.	Unit
	Timing accuracy (monostable) <sup>(1)</sup> $R = 10\text{ k}\Omega$ , $C = 0.1\text{ }\mu\text{F}$		2		%
	Timing shift with supply voltage variations (monostable) <sup>(1)</sup> $R = 10\text{ k}\Omega$ , $C = 0.1\text{ }\mu\text{F}$ , $V_{CC} = +5\text{ V} \pm 1\text{ V}$		0.38		%/V
	Timing shift with temperature <sup>(1)</sup> $T_{min.} \leq T_{amb} \leq T_{max}$		75		ppm/ $^{\circ}\text{C}$
$f_{max}$	Maximum Astable Frequency <sup>(2)</sup> $R_A = 470\text{ }\Omega$ , $R_B = 200\text{ }\Omega$ , $C = 200\text{ pF}$		2.7		MHz
	Astable Frequency Accuracy <sup>(2)</sup> $R_A = R_B = 1\text{ k}\Omega$ to $100\text{ k}\Omega$ , $C = 0.1\text{ }\mu\text{F}$		3		%
	Timing shift with supply voltage variations (astable mode) <sup>(2)</sup> $R_A = R_B = 1\text{ k}\Omega$ to $100\text{ k}\Omega$ , $C = 0.1\text{ }\mu\text{F}$ , $V_{CC} = +5$ to $+12\text{ V}$		0.1		%/V
$t_R$	Output rise time ( $C_{load} = 10\text{ pF}$ )		25		ns
$t_F$	Output fall time ( $C_{load} = 10\text{ pF}$ )		20	-	ns
$t_{PD}$	Trigger propagation delay		100		ns
$t_{RPW}$	Minimum reset pulse width ( $V_{trig} = +5\text{ V}$ )		350		ns

1. See [Figure 4](#).

2. See [Figure 6](#).



**Table 9. Static electrical characteristics**  
 **$V_{CC} = +12\text{ V}$ ,  $T_{amb} = +25\text{ }^{\circ}\text{C}$ , Reset to  $V_{CC}$  (unless otherwise specified)**

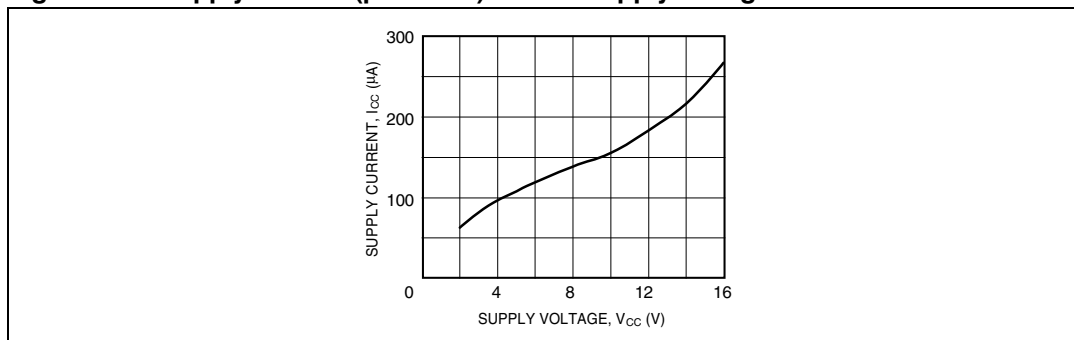
Symbol	Parameter	Min.	Typ.	Max.	Unit
$I_{CC}$	Supply current (no load, high and low states) $T_{min.} \leq T_{amb} \leq T_{max}$		340	800 800	$\mu\text{A}$
$V_{CL}$	Control voltage level $T_{min.} \leq T_{amb} \leq T_{max}$	7.4 7.3	8	8.6 8.7	V
$V_{DIS}$	Discharge saturation voltage ( $I_{dis} = 80\text{ mA}$ ) $T_{min.} \leq T_{amb} \leq T_{max}$		0.09	1.6 2.0	V
$I_{DIS}$	Discharge pin leakage current		1	100	nA
$V_{OL}$	Low level output voltage ( $I_{sink} = 50\text{ mA}$ ) $T_{min.} \leq T_{amb} \leq T_{max}$		1.2	2 2.8	V
$V_{OH}$	High level output voltage ( $I_{source} = -10\text{ mA}$ ) $T_{min.} \leq T_{amb} \leq T_{max}$	10.5 10.5	11		V
$V_{TRIG}$	Trigger voltage $T_{min.} \leq T_{amb} \leq T_{max}$	3.2 3.1	4	4.8 4.9	V
$I_{TRIG}$	Trigger current		10		pA
$I_{TH}$	Threshold current		10		pA
$V_{RESET}$	Reset voltage $T_{min.} \leq T_{amb} \leq T_{max}$	0.4 0.3	1.1	1.5 2.0	V
$I_{RESET}$	Reset current		10		pA

**Table 10. Dynamic electrical characteristics**  
 **$V_{CC} = +12\text{ V}$ ,  $T_{amb} = +25\text{ }^{\circ}\text{C}$ , Reset to  $V_{CC}$  (unless otherwise specified)**

Symbol	Parameter	Min.	Typ.	Max.	Unit
	Timing accuracy (monostable) <sup>(1)</sup> $R = 10\text{ k}\Omega$ , $C = 0.1\text{ }\mu\text{F}$		4		%
	Timing shift with supply voltage variations (monostable) $R = 10\text{ k}\Omega$ , $C = 0.1\text{ }\mu\text{F}$ , $V_{CC} = +5\text{ V} \pm 1\text{ V}$		0.38		%/V
	Timing shift with temperature $T_{min.} \leq T_{amb} \leq T_{max.}$ , $V_{CC} = +5\text{ V}$		75		ppm/ $^{\circ}\text{C}$
$f_{max}$	Maximum astable frequency $R_A = 470\text{ }\Omega$ , $R_B = 200\text{ }\Omega$ , $C = 200\text{ pF}$ , $V_{CC} = +5\text{ V}$		2.7		MHz
	Astable frequency accuracy <sup>(2)</sup> $R_A = R_B = 1\text{ k}\Omega$ to $100\text{ k}\Omega$ , $C = 0.1\text{ }\mu\text{F}$		3		%
	Timing shift with supply voltage variations (astable mode) $R_A = R_B = 1\text{ k}\Omega$ to $100\text{ k}\Omega$ , $C = 0.1\text{ }\mu\text{F}$ , $V_{CC} = 5$ to $+12\text{ V}$		0.1		%/V

1. See [Figure 4](#).

2. See [Figure 6](#).

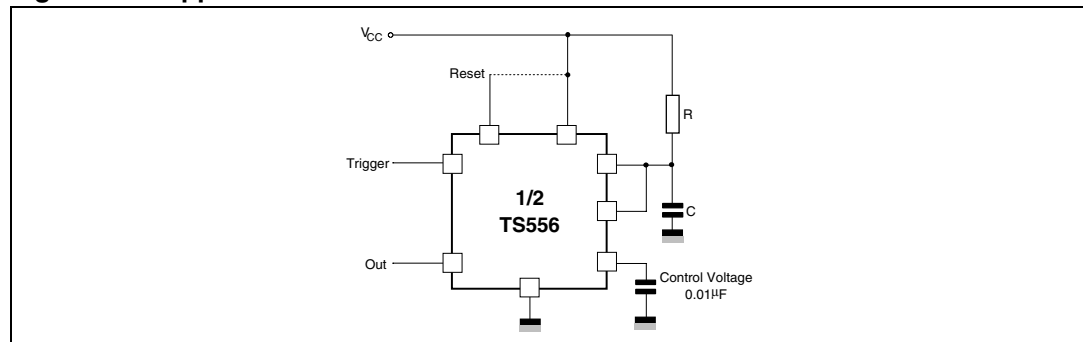
**Figure 3. Supply current (per timer) versus supply voltage**

## 4 Application information

### 4.1 Monostable operation

In the monostable mode, the timer operates like a one-shot generator. Referring to figure 2, the external capacitor is initially held discharged by a transistor inside the timer, as shown in [Figure 4](#).

**Figure 4. Application schematic**



The circuit triggers on a negative-going input signal when the level reaches  $1/3 V_{CC}$ . Once triggered, the circuit remains in this state until the set time has elapsed, even if it is triggered again during this interval. The duration of the output HIGH state is given by  $t = 1.1 R \times C$ .

It can be noticed that since the charge rate and the threshold level of the comparator are both directly proportional to the supply voltage, the timing interval is independent of the supply. Applying a negative pulse simultaneously to the Reset terminal (pin 4) and the Trigger terminal (pin 2) during the timing cycle discharges the external capacitor and causes the cycle to start over. The timing cycle now starts on the positive edge of the reset pulse. While the reset pulse is applied, the output is driven to the LOW state.

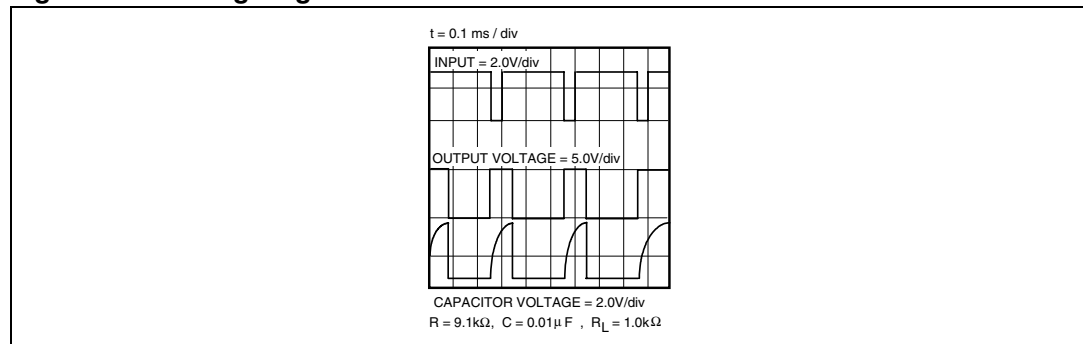
When a negative trigger pulse is applied to pin 2, the flip-flop is set, releasing the short circuit across the external capacitor and driving the output HIGH. The voltage across the capacitor increases exponentially with the time constant  $\tau = R \times C$ .

When the voltage across the capacitor equals  $2/3 V_{CC}$ , the comparator resets the flip-flop which then discharges the capacitor rapidly and drives the output to its LOW state.

[Figure 5](#) shows the actual waveforms generated in this mode of operation.

When Reset is not used, it should be tied high to avoid any possible or false triggering.

**Figure 5. Timing diagram**

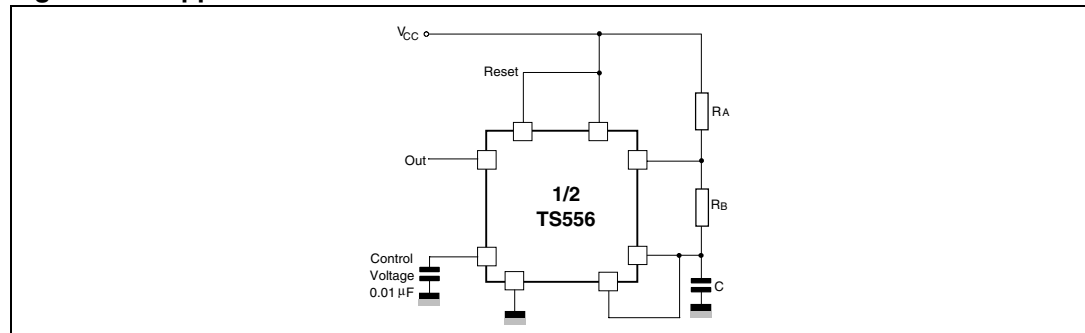


## 4.2 Astable operation

When the circuit is connected as shown in [Figure 6](#) (pins 2 and 6 connected) it triggers itself and runs as a multivibrator. The external capacitor charges through  $R_A$  and  $R_B$  and discharges through  $R_B$  only. Thus the duty cycle may be precisely set by the ratio of these two resistors.

In the astable mode of operation, C charges and discharges between  $1/3 V_{CC}$  and  $2/3 V_{CC}$ . As in the triggered mode, the charge and discharge times and therefore frequency, are independent of the supply voltage.

**Figure 6. Application schematic**



[Figure 7](#) shows actual waveforms generated in this mode of operation.

The charge time (output HIGH) is given by:

$$t_1 = 0.693 (R_A + R_B) C$$

and the discharge time (output LOW) by:

$$t_2 = 0.693 \times R_B \times C$$

Thus the total period T is given by:

$$T = t_1 + t_2 = 0.693 (R_A + 2R_B) C$$

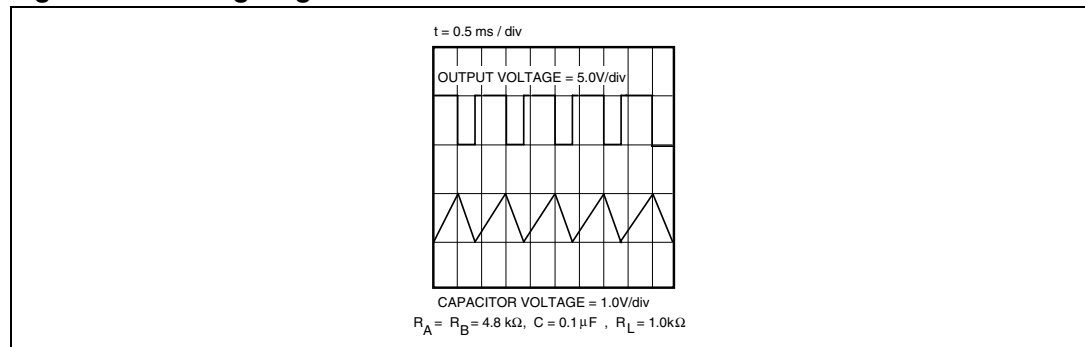
The frequency of oscillation is then:

$$f = \frac{1}{T} = \frac{1.44}{(R_A + 2R_B) C}$$

The duty cycle is given by:

$$D = \frac{R_B}{R_A + 2R_B}$$

**Figure 7. Timing diagram**



## 5 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

## 5.1 DIP14 package information

Figure 8. DIP14 package mechanical drawing

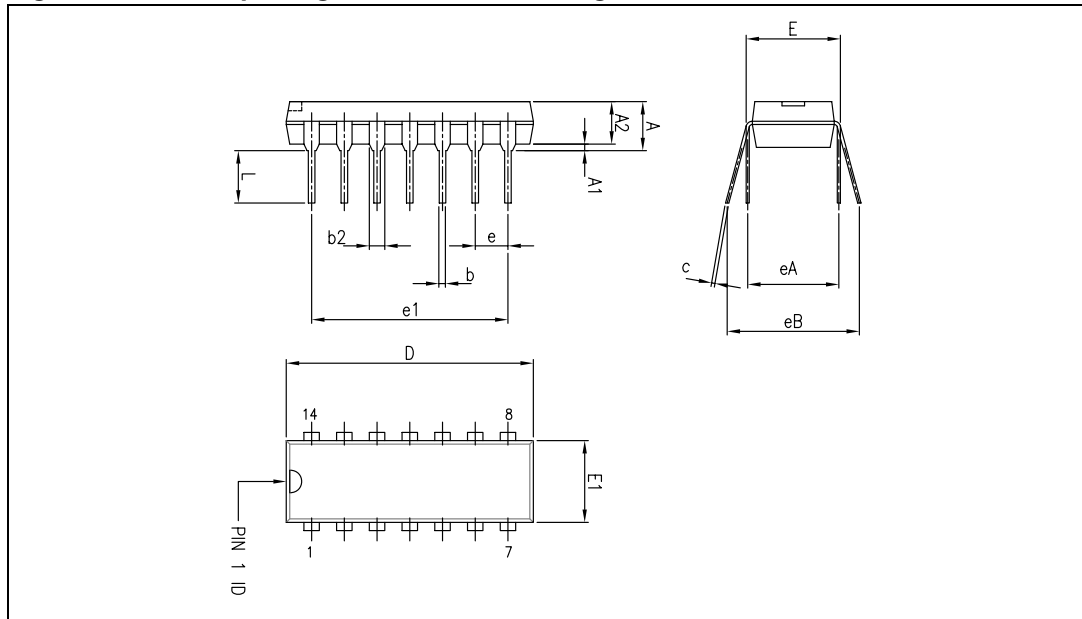


Table 11. DIP14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			5.33			0.21
A1	0.38			0.015		
A2	2.92	3.30	4.95	0.11	0.13	0.19
b	0.36	0.46	0.56	0.014	0.018	0.022
b2	1.14	1.52	1.78	0.04	0.06	0.07
c	0.20	0.25	0.36	0.007	0.009	0.01
D	18.67	19.05	19.69	0.73	0.75	0.77
E	7.62	7.87	8.26	0.30	0.31	0.32
E1	6.10	6.35	7.11	0.24	0.25	0.28
e		2.54			0.10	
e1		15.24			0.60	
eA		7.62			0.30	
eB			10.92			0.43
L	2.92	3.30	3.81	0.11	0.13	0.15

Note: D and E1 dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm.

## 5.2 SO-14 package information

Figure 9. SO-14 package mechanical drawing

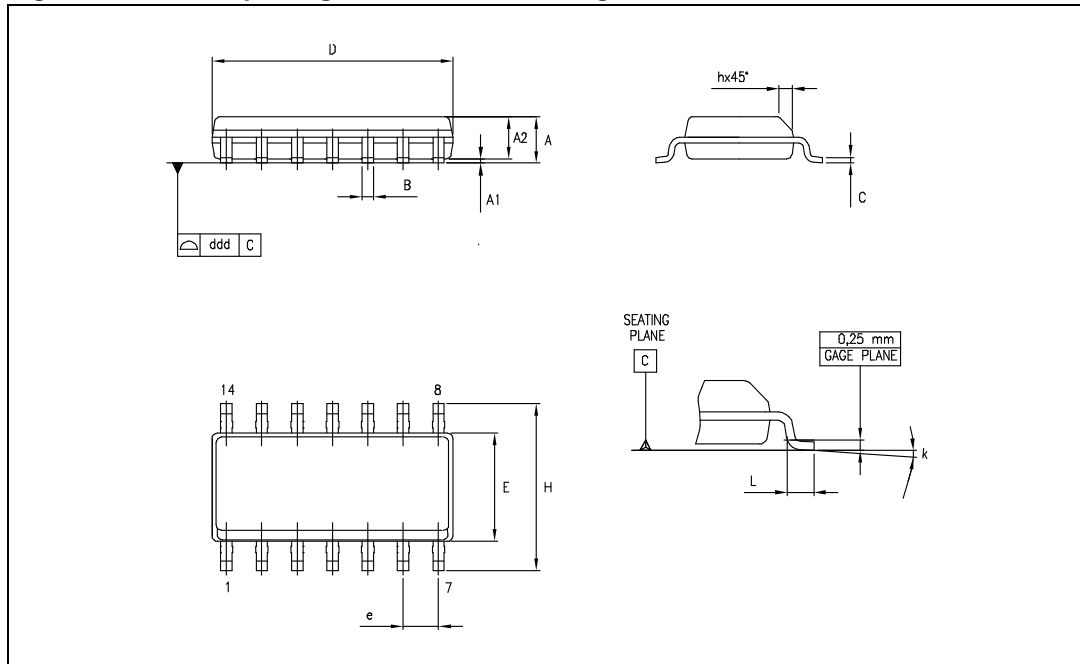


Table 12. SO-14 package mechanical data

Dimensions						
Ref.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	1.35		1.75	0.05		0.068
A1	0.10		0.25	0.004		0.009
A2	1.10		1.65	0.04		0.06
B	0.33		0.51	0.01		0.02
C	0.19		0.25	0.007		0.009
D	8.55		8.75	0.33		0.34
E	3.80		4.0	0.15		0.15
e		1.27			0.05	
H	5.80		6.20	0.22		0.24
h	0.25		0.50	0.009		0.02
L	0.40		1.27	0.015		0.05
k	8° (max.)					
ddd			0.10			0.004

Note: D and F dimensions do not include mold flash or protrusions. Mold flash or protrusions must not exceed 0.15 mm.

## 6 Ordering information

**Table 13. Order codes**

Order code	Temperature range	Package	Packaging	Marking
TS556CN	0°C, +70°C	DIP14	Tube	TS556CN
TS556CD TS556CDT		SO-14	Tube or Tape & reel	556C
TS556IN	-40°C, +125°C	DIP14	Tube	TS556IN
TS556ID TS556IDT		SO-14	Tube or Tape & reel	556I
TS556MN	-55°C, +125°C	DIP14	Tube	TS556MN
TS556MD TS556MDT		SO-14	Tube or Tape & reel	556M



## 7 Revision history

**Table 14. Document revision history**

Date	Revision	Changes
01-Feb-2003	1	Initial release.
28-Oct-2008	2	Document reformatted. Added output current, ESD and thermal resistance values in <a href="#">Table 1: Absolute maximum ratings</a> . Added output current values in <a href="#">Table 2: Operating conditions</a> . Updated <a href="#">Section 5.1: DIP14 package information</a> and <a href="#">Section 5.2: SO-14 package information</a> .

**Please Read Carefully:**

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

**UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.**

**UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.**

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2008 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

[www.st.com](http://www.st.com)

